## LN216RPH

### Square Type

 $\square$  3.0 mm  $\times$  7.0 mm

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Power dissipation	$P_{\mathrm{D}}$	70	mW	
Forward current	I <sub>F</sub> 25		mA	
Pulse forward current *	$I_{FP}$	150	mA	
Reverse voltage	V <sub>R</sub>	4	V	
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-30 to +100	°C	

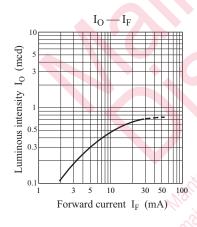
Note) \*: The condition of  $I_{FP}$  is duty 10%, Pulse width 1 msec.

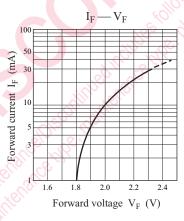
## ■ Lighting Color

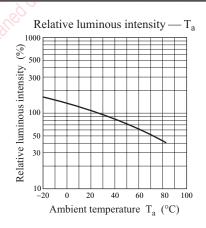
• Red

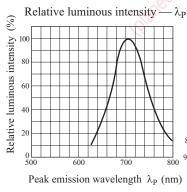
#### ■ Electro-Optical Characteristics $T_a = 25$ °C

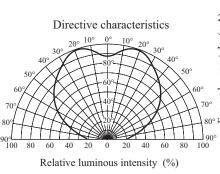
					0	
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I <sub>O</sub>		0.2	0.5	5	mcd
Reverse current	$I_R$	$V_R = 4 V$	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	"116ep.	5	μΑ
Forward voltage	$V_{\rm F}$	$I_F = 20 \text{ mA}$	100,180	2.2	2.8	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 20 \text{ mA}$	dillo	700		nm
Spectral half band width	Δλ	$I_F = 20 \text{ mA}$	<i>'</i>	100		nm

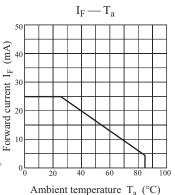








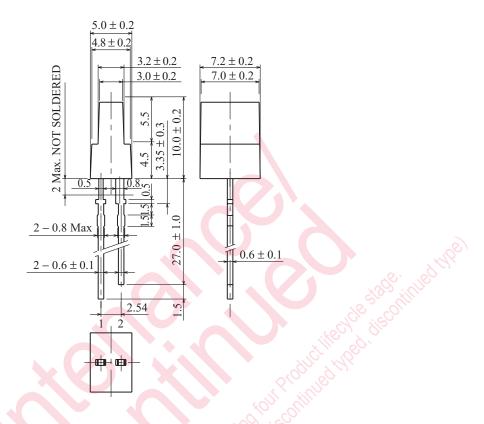




LN216RPH Panasonic

■ Package (Unit: mm)

### LLXFTN2SF160



- Pin name
  - 1: Anode
  - 2: Cathode

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